

L Number	Hits	Search Text	DB	Time stamp
1	4	((("5751553") or ("4538124") or ("5602720") or ("5774342")).PN.	USPAT; EPO	2004/10/15 11:25
-	1071	428/210.ccls.	USPAT; EPO	2004/10/14 16:36
-	160	428/210.ccls. and (((circuit or wiring) adj (board or layer or substrate)) with ceramic)	USPAT; EPO	2004/10/14 17:26
-	4473	((((circuit or wiring) adj (board or layer or substrate)) same (heat adj sink))	USPAT; EPO	2004/10/14 17:27
-	385	((((circuit or wiring) adj (board or layer or substrate)) same ceramic same (heat adj sink))	USPAT; EPO	2004/10/14 18:39
-	177	((((circuit or wiring) adj (board or layer or substrate)) same ceramic same (heat adj sink))) and (recess\$3 or cavity or indent\$5)	USPAT; EPO	2004/10/14 17:45
-	9	((((circuit or wiring) adj (board or layer or substrate)) same ceramic same (heat adj sink))) and ((recess\$3 or cavity or depress\$3 or indent\$5) near3 base)	USPAT; EPO	2004/10/14 17:52
-	3	((((circuit or wiring) adj (board or layer or substrate)) same ceramic same (heat adj sink))) and ((recess\$3 or cavity or depress\$3 or indent\$5) with portion with base)	USPAT; EPO	2004/10/14 17:52
-	1	(metal\$3 with base with carrier with ((cavity or recess\$3 or depress\$3) adj portion))	USPAT; EPO	2004/10/14 17:56
-	70	(prevent with (bending or flexing)) and (ceramic with ((wiring or circuit) adj (board or substrate or layer)))	USPAT; EPO	2004/10/14 18:08
-	0	(ceramic with ((wiring or circuit) adj (board or substrate or layer)) same (reside\$2 with within with (cavity or recess\$3 or depress\$3)))	USPAT; EPO	2004/10/14 18:13
-	0	(ceramic with ((wiring or circuit) adj (board or substrate or layer)) same (reside\$2 with (cavity or recess\$3 or depress\$3)))	USPAT; EPO	2004/10/14 18:13
-	1	(metallic near3 base near3 carrier) same (recess\$3 or depress\$3 or cavity)	USPAT; EPO	2004/10/14 18:16
-	79	(metallic near3 base) same ((recess\$3 or depress\$3 or cavity) near3 portion)	USPAT; EPO	2004/10/14 18:16
-	134	(metallic near3 (base or substrate)) same ((recess\$3 or depress\$3 or cavity) near3 portion)	USPAT; EPO	2004/10/14 18:16
-	5	("4246595" "4672417" "4692791" "4724472" "4866501").PN.	USPAT	2004/10/14 18:28
-	2360	((((circuit or wiring) adj (board or layer or substrate)) with (align\$4 near4 (hole or aperture)))	USPAT; EPO	2004/10/14 18:55
-	0	((((circuit or wiring) adj (board or layer or substrate)) with (align\$4 near4 (hole or aperture)))) and (base with (pole near3 (perpendicular or vertical)))	USPAT; EPO	2004/10/14 18:42
-	5	((((circuit or wiring) adj (board or layer or substrate)) with (align\$4 near4 (hole or aperture)))) and (pole near3 (perpendicular or vertical))	USPAT; EPO	2004/10/14 18:42
-	107	((((circuit or wiring) adj (board or layer or substrate)) with (align\$4 near4 (hole or aperture)))) and (ceramic adj (substrate or layer or board))	USPAT; EPO	2004/10/14 18:44
-	52	((circuit or wiring) adj (board or layer or substrate)) with (alignment with (hole or aperture) with (alignment adj post))	USPAT; EPO	2004/10/14 18:57